



100V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C	
100V	8.3mΩ @ V _{GS} = 10V	98A	

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize $R_{DS(ON)}$, yet maintain superior switching performance. This device is ideal for use in notebook battery power management and load switch.

Applications

- Motor Control
- DC-DC Converters
- Power Management

Features

- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications (PowerDI[®])
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

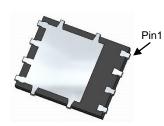
Mechanical Data

- Case: PowerDI5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminal Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.097 grams (Approximate)

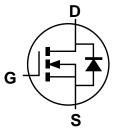
PowerDI5060-8



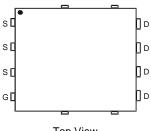
Top View



Bottom View



Internal Schematic



Top View Pin Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
DMT10H010LPS-13	PowerDI5060-8	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



] | | = Manufacturer's Marking T1010SS = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 17 = 2017) WW = Week Code (01 to 53)

Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	100	V		
Gate-Source Voltage			V _{GSS}	±20	V
Operiting the Province Community (1974)	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	9.4 7.5	А
Continuous Drain Current V _{GS} = 10V	Steady State	,		98 62	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	250	Α		
Maximum Continuous Body Diode Forward Current			Is	110	Α
Pulsed Body Diode Current (10µs Pulse, Duty Cycle = 1%)			I _{SM}	250	Α
Avalanche Current (Note 7), L=3mH			I _{AS}	10	Α
Avalanche Energy (Note 7), L=3mH			E _{AS}	150	mJ
V_{DS} Spike, L=0.1mH $t = 10 \mu s$			V _{SPIKE}	110	V

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		P_{D}	1.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{0JA}	99	°C/W
Total Power Dissipation	T _C = +25°C	P _D	139	W
Thermal Resistance, Junction to Case	R _{0JC}	0.9	°C/W	
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

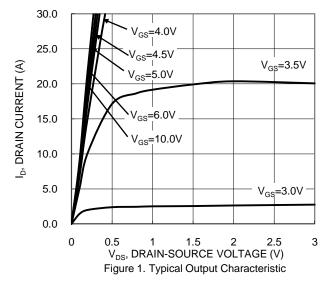
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	1	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	1	1	μΑ	$V_{DS} = 80V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	1	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage	V _{GS(TH)}	1.4	1.9	3.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
		1	6.9	8.3		$V_{GS} = 10V, I_D = 13A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	-	7.5	12	mΩ	$V_{GS} = 6V, I_D = 13A$	
	, ,	_	10	20		$V_{GS} = 4.5V, I_D = 5A$	
Diode Forward Voltage	V_{SD}	_	8.0	1.3	V	V _{GS} = 0V, I _S = 13A	
DYNAMIC CHARACTERISTICS (Note 7)							
Input Capacitance	C _{iss}	_	2592	_		V 50V V 0V	
Output Capacitance	Coss	_	792	_	pF	$V_{DS} = 50V$, $V_{GS} = 0V$ f = 1MHz	
Reverse Transfer Capacitance	C _{rss}		45	_			
Gate Resistance	R_g	_	2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	53.7	_		V 50V L 40A	
Gate-Source Charge	Q _{gs}	_	10.6	_	nC	$V_{DD} = 50V, I_D = 13A,$	
Gate-Drain Charge	Q_{gd}	_	8.2	_		$V_{GS} = 10V$	
Turn-On Delay Time	t _{D(ON)}	_	11.6	_			
Turn-On Rise Time	t _R	_	14.1	_		$V_{DD} = 50V, V_{GS} = 10V,$	
Turn-Off Delay Time	t _{D(OFF)}	_	42.9	_	ns	$I_D = 13A$, $R_g = 6\Omega$	
Turn-Off Fall Time	t _F	_	22	_			
Reverse Recovery Time	t _{RR}	_	49.8	_	ns	1 400 11/11 4000/	
Reverse Recovery Charge	Q _{RR}	_	85.1	_	nC	I _F = 13A, di/dt = 100A/μs	

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.6. Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to product testing.







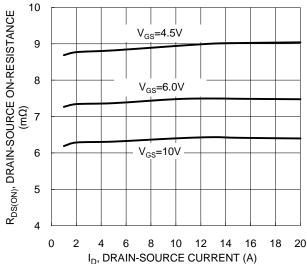


Figure 3. Typical On-Resistance vs. Drain Current

and Gate Voltage

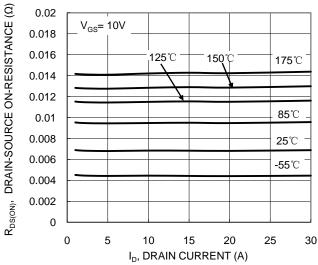
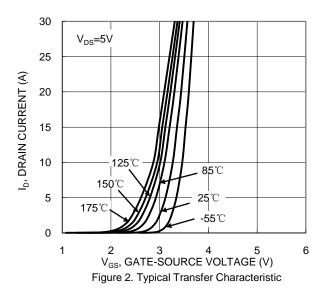
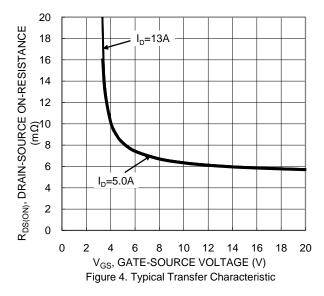


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





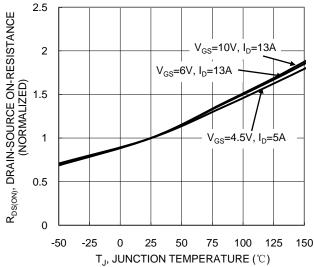


Figure 6. On-Resistance Variation with Temperature





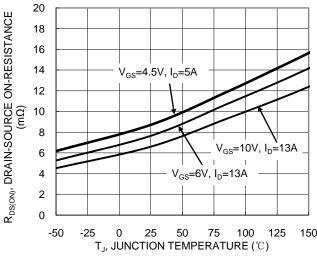
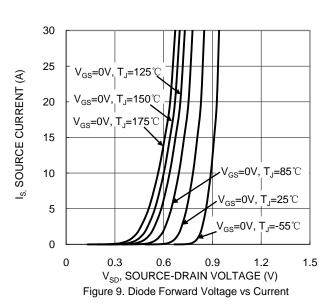


Figure 7. On-Resistance Variation with Temperature



8 6 V_{DS} = 50V, I_D = 13A

20 25 30 35

Qg (nC)

Figure 11. Gate Charge

40 45 50 55

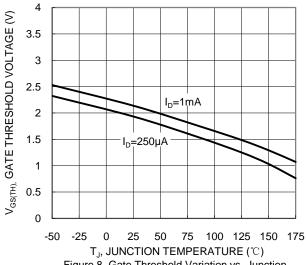


Figure 8. Gate Threshold Variation vs. Junction Temperature

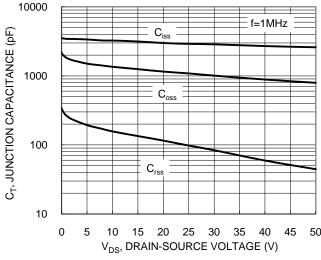


Figure 10. Typical Junction Capacitance

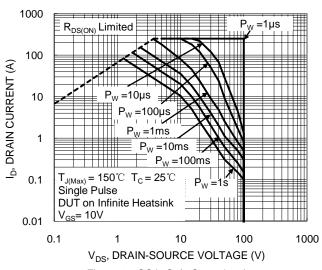


Figure 12. SOA, Safe Operation Area

0 5 10 15

10



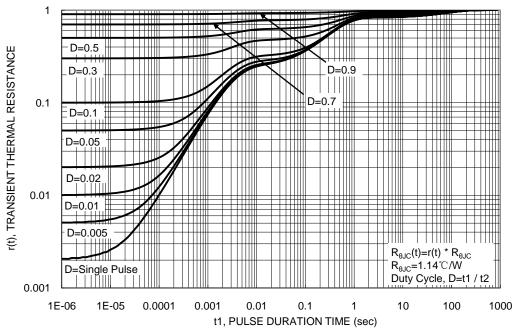


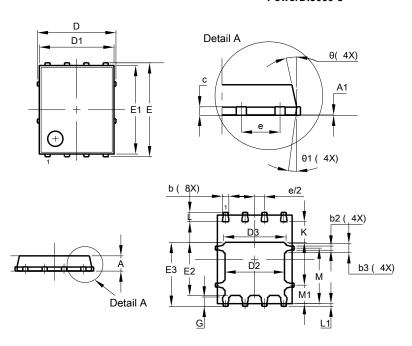
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

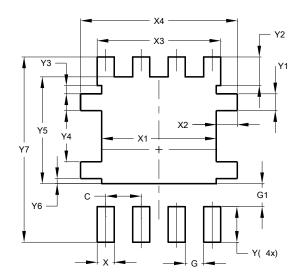


PowerDI5060-8					
Dim	Min	Тур			
Α	0.90	1.00			
A1	0.00 0.05 -				
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	;	5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70 4.10 3.90				
D3	3.90 4.30 4.10				
Е	(6.15 BSC	;		
E1	5.60	5.80			
E2	3.28 3.68 3.4				
E3	3.99 4.39 4.19				
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51 0.71 0.61				
L1	0.100 0.200 0.175				
M	3.235 4.035 3.63				
M1	1.00 1.40 1.21				
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)			
С	1.270			
G	0.660			
G1	0.820			
X	0.610			
X1	4.100			
X2	0.755			
Х3	4.420			
X4	5.610			
Y	1.270			
Y1	0.600			
Y2	1.020			
Y3	0.295			
Y4	1.825			
Y5	3.810			
Y6	0.180			
Y7 6.610				



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